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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Gu-Sung KIM

Art Unit:

2814

Serial No. 10/073,173

Examiner:

Long Pham

Filed: February 13, 2002

Confirmation No. 4677

For: Wafer Level Package with Air Pads and

MANUFACTURING METHOD THEREOF

Attorney Docket No. 259/014

AMENDMENT UNDER 37 C.F.R. § 1.111

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In response to the outstanding Office action, mailed January 30, 2006, the following amendments and remarks are respectfully submitted in connection with the above-identified application:

Amendments to the Claims are reflected in a listing of claims, which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.